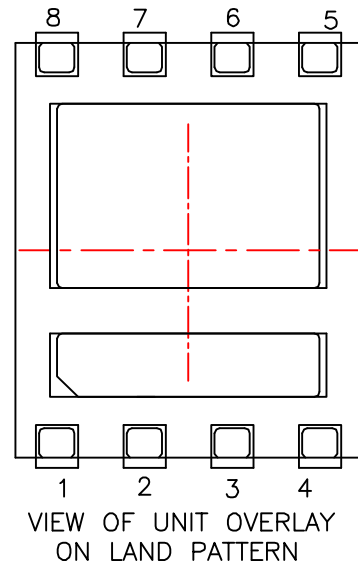
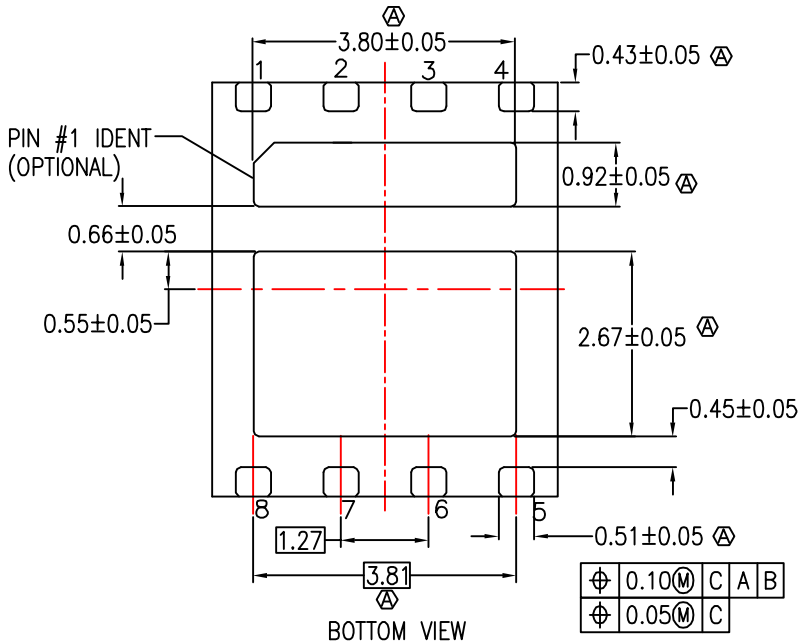
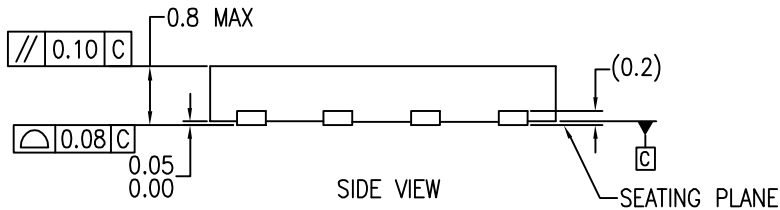
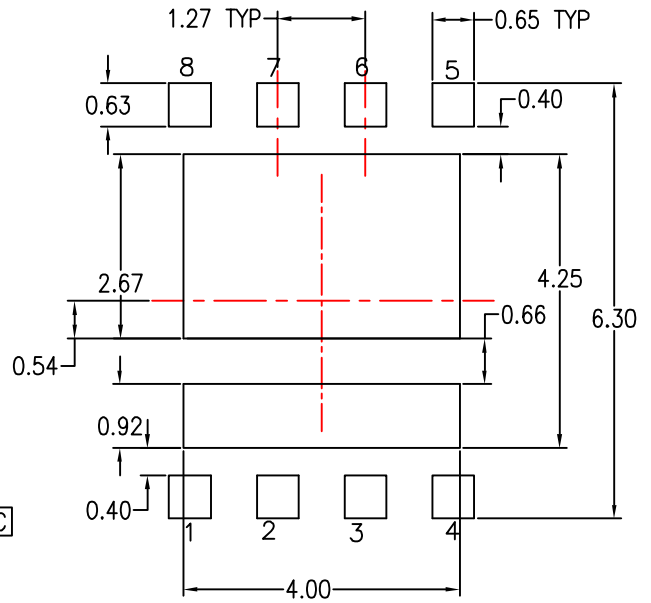
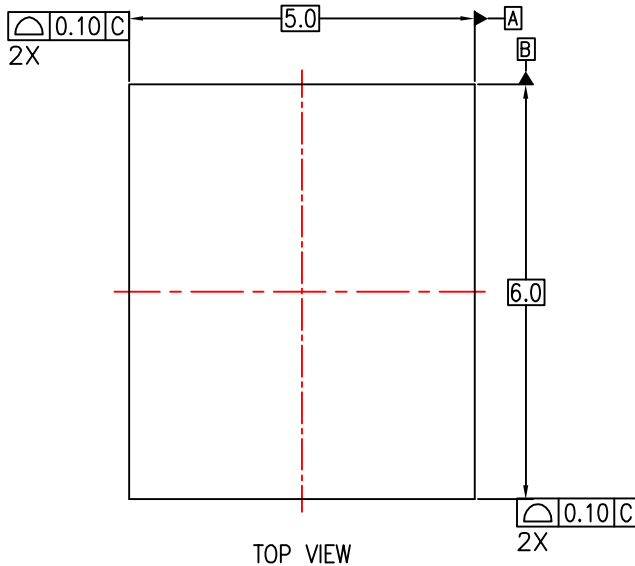


THIS DRAWING IS THE PROPERTY OF FAIRCHILD SEMICONDUCTOR CORPORATION. NO USE THEREOF SHALL BE MADE OTHER THAN AS A REFERENCE FOR PROPOSALS AS SUBMITTED TO FAIRCHILD SEMICONDUCTOR CORPORATION FOR JOBS TO BE EXECUTED IN CONFORMITY WITH SUCH PROPOSALS UNLESS THE CONSENT OF SAID FAIRCHILD SEMICONDUCTOR CORPORATION HAS PREVIOUSLY BEEN OBTAINED. NO PART OF THIS DRAWING SHALL BE COPIED OR DUPLICATED OR ITS CONTENTS DISCLOSED. THE INFORMATION CONTAINED ON THIS DRAWING IS CONFIDENTIAL AND PROPRIETARY.

REVISIONS				
LTR	DESCRIPTION	EDCN	DATE	BY/APP'D
1	RELEASE TO DOCUMENT CONTROL	MKT-MLP08KR1	06-09-06	H.ALLEN



Φ 0.10(M)	C	A	B
Φ 0.05(M)	C		

NOTES:

- ⊕ DOES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO-229. DATED 11/2001.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP08Krev1

APPROVALS		DATE	FAIRCHILD		
DRAWN	LY LIM	13-07-06	Bayan Lepas, FIZ, 11900, Penang, Malaysia.		
DFTG. CHK	J CHAN	24-07-06			
ENGR. CHK					
			8LD,MLP,DUAL,NON-JEDEC, 5X6MM, DUAL DAP		
PROJECTION		SCALE	SIZE	DRAWING NUMBER	REV
		N/A	N/A	MKT-MLP08K	1
DO NOT SCALE DRAWING			SHEET 1 of 1		